

ASI-T-350ZA3SRN/AC

ITEM	STANDARD VALUES	UNITS
LCD type	3.5"TFT	
Dot arrangement	320(RGB)×480	dots
Color filter array	RGB vertical stripe	
Display mode	IPS / Transmissive / Normally Black	
Viewing Direction	80/80/80/80 deg(U/D/L/R @ C/R>10)	
Driver IC	ST7796S	
Module size	53.76(W)×84.18(H)×2.15(T)	mm
Active area	48.96(W)×73.44(H)	mm
Dot pitch	0.153(W)×0.153(H)	mm
Interface	SPI + 18-bit RGB interface	
Operating temperature	-10 ~ +60	C
Storage temperature	-20 ~ +70	°C
Back Light	6 White LED in parallel	
Weight	TBD	g



Revision Record

REV NO.	REV DATE	CONTENTS	Note
V01	2017.12.19	NEW ISSUE	



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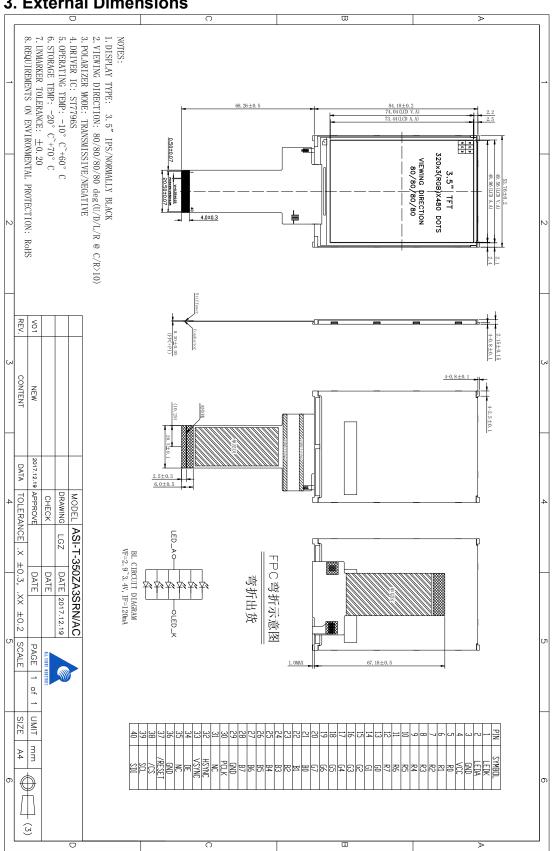


2. General Information

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3. External Dimensions





4. Interface Description

Pin	Symbol	Description.
1	VLED-	LED backlight (Cathode).
2	VLED+	LED backlight (Anode).
3	GND	Ground.
4	VDD	Power supply.
5~12	R0~R7	Red Data.
13~20	G0~G7	Green Data.
21~28	B0~B7	Blue Data.
29	GND	Ground.
30	PCLK	Dot clock signal input. Latching input data at its rising edge.
31	NC	NC.
32	HSYNC	Horizontal sync input. Negative polarity.
33	VSYNC	Vertical sync input. Negative polarity.
34	DE	Data enable input. Active high to enable the input data bus.
35	NC	NC.
36	GND	Ground.
37	/RESET	Reset input pin, Active "L".
38	/CS	Chip select input pin ("Low" enable) in MPU I/F and SPI I/F.
39	SCL	Serial Clock when operates in the serial interface
40	SDI	Serial input signal in SPI I/F.

5. Absolute Maximum Ratings

Item	Symbol	Min.	Max.	Unit
Analog Supply Voltage	VCC	-0.3	3.3	V
Input Voltage	Vin	-0.3	VCC+0.3	V
Operating Temperature	Тор	-10	60	°C
Storage Temperature	Тѕт	-20	70	°C
Storage Humidity	HD	20	90	%RH

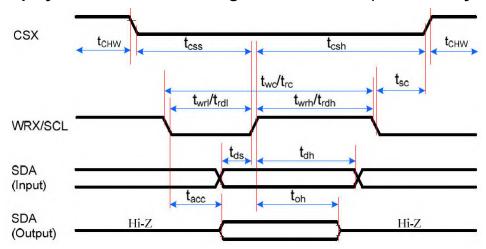
6. DC Characteristics

Item	Symbol	Min.	Тур.	Max.	Unit	Remark
Analog Supply Voltage	VCC	2.65	2.8	3.3	٧	-
Input High Voltage	V_{IH}	0.7VCC	-	VCC	٧	Digital input pins
Input Low Voltage	V _{IL}	GND	-	0.3VCC	٧	Digital input pins
Output High Voltage	V _{OH}	0.8VCC	-	VCC	٧	Digital output pins
Output Low Voltage	V_{OL}	GND	-	0.2VCC	٧	Digital output pins
I/O Leak Current	ILI	-1.0	-	1.0	uA	-



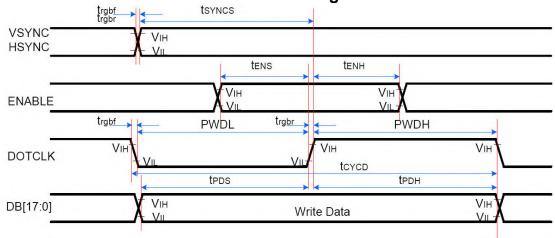
7. Timing Characteristics

7.1 Display Serial Interface Timing Characteristics (3-line SPI system)



Signal	Symbol	Parameter	min	max	Unit	Description
tsc		SCL-CSX	15	-	ns	
csx t	tchw	CSX H Pulse Width	40	- 14	ns	
CSX	tcss	Chip select time (Write)	60	-	ns	
	tcsh	Chip select hold time (Read)	65		ns	
	twc	Serial Clock Cycle (Write)	66	-	ns	
	twrh	SCL H Pulse Width (Write)	15		ns	
SCL	twrl	SCL L Pulse Width (Write)	15		ns	
trc trdh	trc	Serial Clock Cycle (Read)	150		ns	
	trdh	SCL H Pulse Width (Read)	60	14	ns	
	trdl	SCL L Pulse Width (Read)	60		ns	
SDA/SDI	tds	Data setup time (Write)	10	-	ns	
(Input)	tdh	Data hold time (Write)	10	-	ns	
SDA/SDO ta	tacc	Access time (Read)	10	50	ns	For maximum CL=30pF
(Output)	toh	Output disable time (Read)	15	50	ns	For minimum CL=8pF

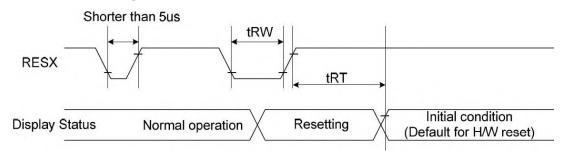
7.2 Parallel 18/16-bit RGB Interface Timing Characteristics





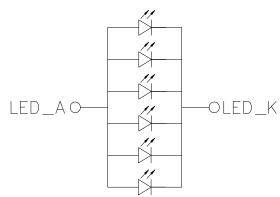
Signal	Symbol	Parameter	min	max	Unit	Description
VSYNC/	tsyncs	VSYNC/HSYNC setup time	15	-	ns	
HSYNC	tsynch	VSYNC/HSYNC hold time	15	-	ns	
ENABLE	tens	ENABLE setup time	15	-	ns	
ENABLE	t _{ENH}	ENABLE hold time	15	-	ns	
DD (00-01	tpos	Data setup time	15	-	ns	16-/18-/24-bit bus
DB [23:0]	t _{PDH}	Data hold time	15	-	ns	RGB interface mode
	PWDH	DOTCLK high-level period	20	-	ns	
DOTCLK	PWDL	DOTCLK low-level period	20	-	ns	
DOTOLK	tcyco	DOTCLK cycle time	50	1-1	ns	
	t _{rgbr} , t _{rgbf}	DOTCLK,HSYNC,VSYNC rise/fall time		15	ns	

7.3 Reset Timing Characteristics



Signal	Symbol	Parameter	Min	Max	Unit
	tRW	Reset pulse duration	10		uS
RESX		Deseterned		5 (note 1,5)	mS
	tRT	Reset cancel		120 (note 1,6,7)	mS

8. Backlight Charasterics



Item	Symbol	MIN	TYP	MAX	UNIT	Test Condition
Supply Voltage	Vf	2.9	3.2	3.4	V	If=120mA
Supply Current	If	-	120	150	mA	-
Luminous Intensity for LCM	-	260	300	-	Cd/m ²	If=120mA
Life Time	-	20000	-	-	Hr	If=120mA
Backlight Color	White					



9. Optical Characteristics

Item		Symbol	Conditions	Specifications (typ)	Unit	Note
Transmittance		Т%		4.3	%	All left side data are
Contras	t Ratio	CR	Viewing	700		based on INX's
Response Time		Ton+ Toff	normal angle $q_X = q_Y = 0^\circ$	30	ms	following condition -
		q _{X+}		80		2.AR: 67.5% 3.Light Source: INX LED BLU 4.Machine: DMS 803 5. Vwhite > 5.0 V, Vdark < 0.3V 6. Polarizer: NPF-TEGQ1465DUHC
Viewing Angle	Hor.	q _X .	Center CR>10	80	deg.	
	Ver.	q _{Y+}		80		
		q _Y .		80		
	Red	X _R		0.660		
	Red	YR		0.325		
	Cusan	X _G		0.277		
CF only	Green	Y _G	Viewing	0.568		Under C light
Chromaticity	Divis	X _B	normal angle $q_X = q_Y = 0^\circ$	0.145		Simulation
	Blue	YB		0.072		
	14/L-14-	X _W		0.309		
	White	Yw		0.332		

^{*}Note (1) Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression.

Contrast Ratio (CR) = L63 / L0

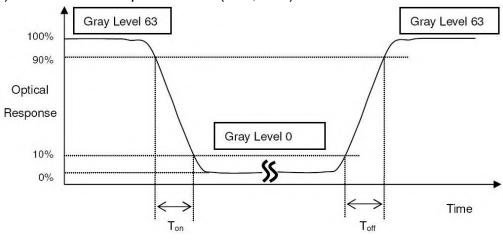
L63: Luminance of gray level 63

L 0: Luminance of gray level 0

CR = CR(5)

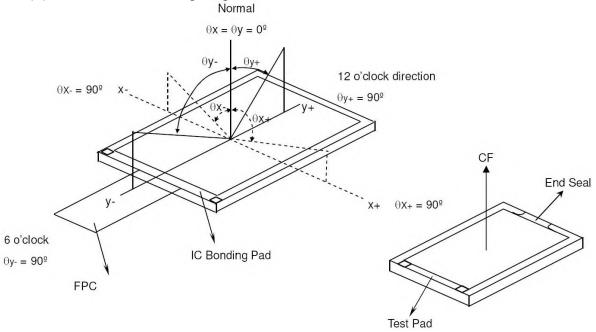
CR (X) is corresponding to the Contrast Ratio of the point X at Figure in Note (5).

*Note (2) Definition of Response Time (Ton, Toff):



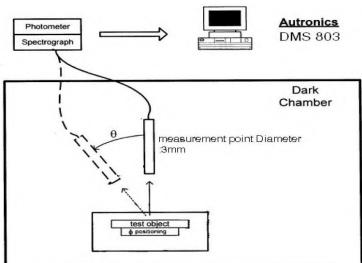


*Note(3) Definition of Viewing Angle



*Note (4) Measurement Set-Up:

The LCD module should be stabilized at a given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 20 minutes in a windless room.





10. Reliability Test Conditions And Methods

NO.	TEST ITEMS	TEST CONDITION	INSPECTION AFTER TEST
1)	High Temperature Storage	70°C±2°C×96Hours	
2	Low Temperature Storage	-20℃±2℃×96Hours	
3	High Temperature Operating	60℃±2℃×96Hours	Inspection after 2~4hours
4	Low Temperature Operating	-10℃±2℃×96Hours	storage at room temperature,the samples should be free from
(5)	Temperature Cycle(Storage)	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$	defects: 1,Air bublle in the LCD. 2,Sealleak. 3,Non-display. 4,Missing segments.
6	Damp Proof Test (Storage)	50℃±5℃×90%RH×96Hours	5,Glass crack. 6,Current IDD is twice higher than initial value.
7	Vibration Test	Frequency:10Hz~55Hz~10Hz Amplitude:1.5M X,Y,Z direction for total 3hours (Packing Condition)	7,The surface shall be free from damage. 8,The electric charateristic requirements shall be
8	Drooping Test	Drop to the ground from 1M height one time every side of carton. (Packing Condition)	satisfied.
9	ESD Test	Voltage:±8KV,R:330Ω,C:150PF,Air Mode,10times	

REMARK:

- 1,The Test samples should be applied to only one test item.
- 2,Sample side for each test item is 5~10pcs.
- 3, For Damp Proof Test, Pure water (Resistance $> 10M\Omega$) should be used.
- 4,In case of malfunction defect caused by ESD damage,if it would be recovered to normal state after resetting,it would be judge as a good part.
- 5,EL evaluation should be excepted from reliability test with humidity and temperature:Some defects such as black spot/blemish can happen by natural chemical reaction with humidity and Fluorescence EL has.
- 6, Failure Judgment Criterion: Basic Specification Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.



11. Inspection Standard

This standard apply to TFT module

1. Spot check plan:

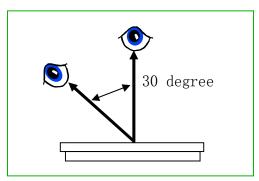
According to spot check level <code>II</code>,MIL-STD-105D Level <code>II</code>,the rank of accept or reject is below:

3A & 2A Levels: major non-conformance: AQL 0.25;

minor non-conformance: AQL 4.0

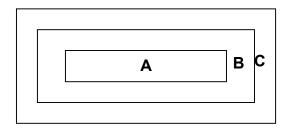
A Level: major non-conformance: AQL0.65; minor non-conformance: AQL 1.

2. Inspection condition:



Under daylight lamp 20 $\sim\!40\text{W}_{\odot}$ product distance inspector'eye 30cm,incline degree 30° $_{\circ}$

3. LCD area define:



Area A: display area

Area B: VA area

Area C: out of VA area, not in sight after assemby

Remark :non-conformance at area C,but is OK that isn't influence raliability of product & assembly by customer.



4. Inspection standard

4.1 Major non-conformance

NO.	Item	Item Inspection standard		
4.1.1	Function non-confor mance	No display, display abnormaly Niss line, short B/L no function or function abnormaly TP no function	major	
4.1.2	miss	No matter miss what component	.,	
4.1.3	Out of size	Module dimension out of spec		

4.2 Appearance non-conformance

NO.	Item	Inspection standard					Rate	
	Black or white spot (power on)	$\Phi = \frac{(x+y)}{2}$		ice defi	neΦ) y	
		A grade						
		area		Most approve q'ty				
		size (mm	mm) A B		В	C	;	
4.2.1		Ф≤0.1	0		ignore			Minor
		0.10<Φ≤	0.15		3			
		0.15<Φ≤	0.20		2	igno	ore	
		0.20<Φ≤0.25		1				
		0.25<Ф		0				
		Most approv	e 4 daı	mages,	dot to dot	≥10mm		
	Black or white line (power on)	A grade						_
		Size(mm)		Most approve q'ty				
		L(length)	W(w	ridth)	Α	В	С	
		ignore	W≤	0.03	igı	nore		
4.2.2		L≤5.0		3< 0.05		2		Minor
		L≤3.0		05< 0.07		1	ignore	
			0.07	′ <w< td=""><td colspan="2">Treat with dot non-conformance</td><td></td><td></td></w<>	Treat with dot non-conformance			
		Most approv	e 3 da	mages,	line to line	e ≥10mm		



4.2.3	Polarizer position	polarizer attach meet drawing, disallow out of LCD. polarizer must cover display area (special require unless)	Minor
4.2.4	LCD non-conf ormance	(i) crash at side (remark: S=ITO length) X Y Z 	Minor
4.2.5	Contrast voltage warp	VOP/VIcd voltage of confirmed sample ±0.15V	Minor
4.2.6	color	Color & luminance of module scope reference spec	Minor
4.2.7	Cross talk	Reference confirmed limit sample	Minor



12. Handling Precautions

12.1 Mounting method

The LCD module consists of two thin glass plates with polarizes which easily be damaged. And since the module in so constructed as to be fixed by utilizing fitting holes in the printed circuit board.

Extreme care should be needed when handling the LCD modules.

12.2 Caution of LCD handling and cleaning

When cleaning the display surface, Use soft cloth with solvent

[recommended below] and wipe lightly

- Isopropyl alcohol
- Ethyl alcohol

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface.

Do not use the following solvent:

- Water
- Aromatics

Do not wipe ITO pad area with the dry or hard materials that will damage the ITO patterns Do not use the following solvent on the pad or prevent it from being contaminated:

- Soldering flux
- Chlorine (Cl) , Salfur (S)

If goods were sent without being sili8con coated on the pad, ITO patterns could be damaged due to the corrosion as time goes on.

If ITO corrosion happen by miss-handling or using some materials such as Chlorine (CI), Salfur (S) from customer, Responsibility is on customer.

12.3 Caution against static charge

The LCD module use C-MOS LSI drivers, so we recommended that you:

Connect any unused input terminal to Vdd or Vss, do not input any signals before power is turned on, and ground your body, work/assembly areas, assembly equipment to protect against static electricity.

12.4 packing

- Module employ LCD elements and must be treated as such.
- Avoid intense shock and falls from a height.
- To prevent modules from degradation, do not operate or store them exposed direct to sunshine or high temperature/humidity

12.5 Caution for operation

- It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life.
- An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.
- Response time will be extremely delayed at lower temperature then the operating temperature range and on the other hand at higher temperature LCD's how dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, which will come back in the specified operation temperature.
- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit.

Usage under the maximum operating temperature, 50%Rh or less is required.



12.6 storage

In the case of storing for a long period of time for instance, for years for the purpose or replacement use, the following ways are recommended.

- Storage in a polyethylene bag with the opening sealed so as not to enter fresh air outside in it.
 And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light's keeping the storage temperature range.
- Storing with no touch on polarizer surface by the anything else.
 [It is recommended to store them as they have been contained in the inner container at the time of delivery from us

12.7 Safety

- It is recommendable to crash damaged or unnecessary LCD's into pieces and wash off liquid crystal by either of solvents such as acetone and ethanol, which should be burned up later.
- When any liquid leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water

13. Precaution For Use

13.1

A limit sample should be provided by the both parties on an occasion when the both parties agreed its necessity. Judgment by a limit sample shall take effect after the limit sample has been established and confirmed by the both parties.

13.2

On the following occasions, the handing of problem should be decided through discussion and agreement between responsible of the both parties.

- When a question is arisen in this specification
- When a new problem is arisen which is not specified in this specifications
- When an inspection specifications change or operating condition change in customer is reported, and some problem is arisen in this specification due to the change
- When a new problem is arisen at the customer's operating set for sample evaluation in the customer site.

14. Packing Method

